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Country:

JP Japan

Kind:

Inventor(s):

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Applicant(s):

YASKAWA ELECTRIC MFG CO LTD

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Issued/Filed Dates:

Jan. 25, 1983 / July 17, 1981

Application Number:

JP1981000110756

IPC Class:

B23K 35/30; C22C 9/04;

Abstract:

Purpose: To provide phosphor copper solder with which restrained cracking is difficult to arise by mixing and melting specific ratios of

phosphor, zinc, copper, titanium, and zirconium.

Constitution: Phosphor copper contg., by weight %, 1W9% phosphor, 0.5W45% zinc, 52W83.5% copper, and 0.05W1.5% titanium and/or zirconium is produced by melting. Despite the restraining of base materials, said phosphor copper solder does not generate any micro-cracks, is easy to work with and is obtainable at

a low cost.

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Other Abstract Info:

CHEMABS 099(04)026680R

Foreign References:

(No patents reference this one)



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